



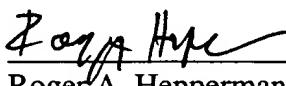
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PATENTIN THE UNITED STATES PATENT  
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|                                     |   |  |
|-------------------------------------|---|--|
| Applicant(s):                       | ) | <b>CERTIFICATE OF MAILING</b>  |
| Daniel D. Christensen et al.        | ) | I hereby certify that this paper and the   |
| Serial No.: 09/850,300 ✓            | ) | documents referred to as enclosed therewith are                                    |
| Title: Wiring Fault Detection,      | ) | being deposited with the United States Postal                                      |
| Diagnosis and Reporting for Process | ) | Service as first class mail, postage prepaid, on                                   |
| Control Systems                     | ) | December 6, 2002, in an envelope addressed to                                      |
| Filed: May 7, 2001                  | ) | Commissioner for Patents, Washington, D.C.   |
| Group Art Unit: 2858                | ) | 20231  |
| Examiner: To Be Determined          | ) |  |
|                                     | ) | Roger A. Heppermann  |
|                                     | ) | Registration No.: 37,641   |

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

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Commissioner for Patents  
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Sir:

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Pursuant to the duty of disclosure under 37 C.F.R. § 1.56, the information identified on the enclosed Form PTO-1449 is disclosed to the Examiner for consideration in connection with the above-identified patent application. Copies of the issued patents listed on the Form PTO-1449 are enclosed herewith.

This Supplemental Information Disclosure Statement is being submitted before receipt of a first Office Action on the merits, and consequently should be considered by the Patent Office without payment of a fee. See 37 C.F.R. § 1.97(b). Furthermore, each item of information contained in this Supplemental Information Disclosure Statement was cited or originated in a communication from a foreign (GB) patent office in a counterpart foreign (GB) application not more than three months prior to the filing (mailing) of this Supplemental Information Disclosure Statement. For this further reason, no fee is due for consideration of this information. See, 37 C.F.R. § 1.97(c)(1). However, please charge any necessary fees due

in connection with consideration of this Supplemental Information Disclosure Statement to  
Deposit Account No. 13-2855. A copy of this paper is enclosed herewith.

Respectfully submitted,

By: 

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